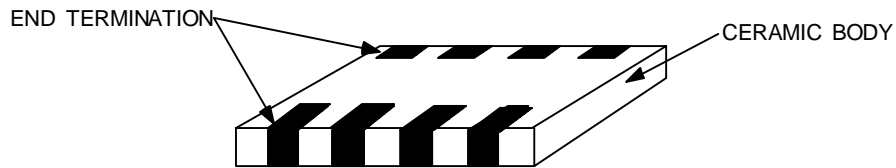


## FEATURE



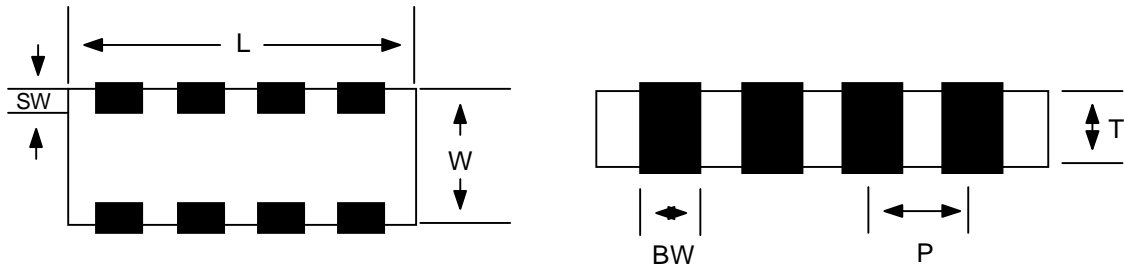
- Reduction in required real estate(more than 50%)
- Reduction cost, Space and time for placement on PCB
- Reduction in number of solder joints
- Easier PCB design
- Reduced waste from tape and reel packaging process
- Protect EMI bypassing digital signal line noise

## PART NUMBER CODE

**CL**   **A**   **4**   **C**   **101**   **K**   **B**   **N**   **E**  
(1)   (2)   (3)   (4)   (5)   (6)   (7)   (8)   (9)

- (1) Samsung Multilayer Ceramic Chip Capacitor
- (2) Capacitor Array
- (3) Array Type
- (4) Capacitance Temperature Characteristics
- (5) Nominal Capacitance
- (6) Capacitance Tolerance(NPO:"K" only, X7R:"M" only)
- (7) Rated Voltage
- (8) Thickness Option
- (9) Packaging Type("E" only)

## CONFIGURATION AND DIMENSIONS



unit:mm

Type	Size(inch)	Element	L	W	T	BW	SW	P
4	0612	4	3.2+/-0.2	1.6+/-0.2	1.35 max	0.4+/-0.2	0.1 min	0.8+/-0.2

## ARRAY TYPE(SIZE)

CODE	NUMBER OF CAPS	SIZE	
4	4	UNIT(mm)	UNIT(inch)
		3.2 x 1.6	06 x 12

## CAPACITANCE TEMPERATURE CHARACTERISTIC

CODE	TEMP. CHARACTERISTIC		TEMP. RANGE
# C	COG	0+/-30 (PPM/C)	-55 ~ +125 C
B	X7R	+/-15%	-55 ~ +125 C
F	Y5V	+22~ -82%	-30 ~ + 85 C

### \* Temperature Characteristics

Temperature Characteristics	below 2.0pF	2.2 ~ 3.9pF	above 4.0pF	above 10pF
#C	CK	CJ	CH	CG/CH

K : +/- PPM/c    J : +/-120 PPM/c    H : +/-60 PPM/c    G : +/-30 PPM/c

## NOMINAL CAPACITANCE

The value of nominal capacitance is expressed in pico-Farad(pF) with a three-digit number.

The first two digits denote significant figures and the last digit denotes the multiple of 10 in pF.

For values below 1pF, the letter "R" is used as the decimal point and the last digit becomes significant.

**example**    100 = 10 x 10<sup>0</sup> = 10pF            222 = 22 x 10<sup>2</sup> = 2200pF  
                   020 = 2 x 10<sup>0</sup> = 2pF            1R5 = 1.5pF

## CAPACITANCE TOLERANCE

CHAR.	TOLERANCE		NOMINAL CAPACITANCE
C	* J (+/- 5 % )	MORE THAN 10pF	E-12 SERIES
	K (+/-10 % )		
B	* J (+/-5%), * K (+/-10%), M (+/-20%)		E-6 SERIES
F	Z ( +80 ~ -20% )		E-6 SERIES

Please Consult us for special tolerances. \* : Option

## RATED VOLTAGE

Symble	Rated Voltage(Vdc)
O	16V
A	25V
B	50V
C	100V

## THICKNESS OPTION

Symbol	Description of the Code
N	Standard thickness (please refer to standard thickness table on next page)
A	Thinner than standard thickness
B	Thicker than standard thickness

## PACKAGING TYPE

Symbol	Packaging
E	Embossed Tape, 7" Reel

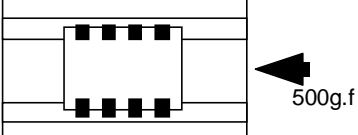
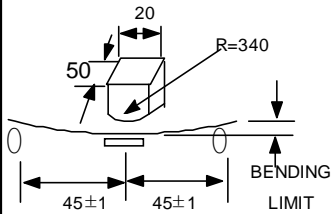
## CAPACITANCE RANGE

THICKNESS 0.85+/-0.1mm

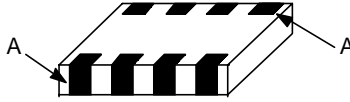
Temperature Characteristics	CH	X7R			Y5V		
Rated Voltage(DC)	50V	16V	25V	50V	16V	25V	50V
Capacitance(pF)							
10	█						
15	█						
22	█						
33	█						
47	█						
68	█						
100	█						
150	█						
220	█						
330	█						
470	█			█			
680							
1000							
1500							
3300							
4700							
10000			█	█			█
22000		█				█	
47000							█
100000		█			█	█	
150000					█		

Please contact us for special capacitance and high voltage(100V)

## RELIABILITY AND TEST CONDITIONS

NO	ITEM		PERFORMANCE	TEST CONDITION											
1	APPEARANCE		NO ABNORMAL EXTERIOR APPEARANCE.	THROUGH MICROSCOPE(x10)											
2	INSULATION RESISTANCE		10,000Mohm OR 500Mohm uF PRODUCT WHICHEVER IS SMALLER. (RATED VOLTAGE IS BELOW 16V 10,000Mohm OR 100Mohm uF)	RATED VOLTAGE SHALL BE APPLIED. MEASUREMENT TIME IS 60 ~ 120 SEC.											
3	WITHSTANDING VOLTAGE		NO DIELECTRIC BREAKDOWN OR MECHANICAL BREAKDOWN.	CLASS I:300% OF THE RATED VOLTAGE FOR 1~5 SEC, CLASS II:250% OF THE RATED VOLTAGE FOR 1~5 SEC IS APPLIED LESS THAN 50mA CURRENT.											
4	CAPACITANCE	CLASS I	WITHIN THE SPECIFIED TOLERANCE.	CAPACITANCE	FREQUENCY	VOLTAGE									
				1,000pF AND BELOW	1MHz+/-10%	0.5 ~ 5 Vrms									
		MORE THAN 1,000pF		1KHz+/-10%	1.0+/-0.2Vrms										
		FREQUENCY		VOLTAGE											
		CLASS II	WITHIN THE SPECIFIED TOLERANCE.	1KHz+/-10%	1.0+/-0.2Vrms										
5	Q	CLASS I	30pF AND OVER : Q >=1,000 LESS THAN 30pF: Q >=400 +20C ( C : CAPACITANCE )	CAPACITANCE	FREQUENCY	VOLTAGE									
				1,000pF AND BELOW	1MHz+/-10%	0.5 ~ 5 Vrms									
				MORE THAN 1,000pF	1KHz+/-10%	1.0+/-0.2Vrms									
6	Tan delta	CLASS II	<table border="1"> <thead> <tr> <th>CHAR.</th> <th>25V and over</th> <th>16V</th> </tr> </thead> <tbody> <tr> <td>B</td> <td>0.025 MAX</td> <td>0.035 MAX</td> </tr> <tr> <td>F</td> <td>0.05 MAX</td> <td>0.07 MAX (C&lt;1.0uF) 0.09 MAX (C&gt;=1.0uF)</td> </tr> </tbody> </table>	CHAR.	25V and over	16V	B	0.025 MAX	0.035 MAX	F	0.05 MAX	0.07 MAX (C<1.0uF) 0.09 MAX (C>=1.0uF)	FREQUENCY		VOLTAGE
				CHAR.	25V and over	16V									
				B	0.025 MAX	0.035 MAX									
F	0.05 MAX	0.07 MAX (C<1.0uF) 0.09 MAX (C>=1.0uF)													
		1KHz+/-10%	1.0+/-0.2Vrms												
7	ADHESIVE STRENGTH OF TERMINATION		NO INDICATION OF PEELING SHALL OCCUR ON THE TERMINAL ELECTRODE.	A 500g.f PULL FORCE SHALL BE APPLIED FOR 10+/-1SECOND.											
															
8	BENDING STRENGTH	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	BENDING SHALL BE APPLIED TO THE LIMIT(1mm) WITH 0.3mm/SEC.											
															

# Multilayer Chip Capacitors – Array

NO	ITEM	PERFORMANCE	TEST CONDITION										
9	SOLDERABILITY	<p>MORE THAN 75% OF THE TERMINAL SURFACE IS TO BE SOLDERED NEWLY, SO METAL PART(A) DOES NOT COME OUT OR DISSOLVE.</p> 	<p>SOLDER TEMPERATURE : 230+/-5C            SOLDER : H63A            FLUX : ROSIN            PRE-HEATING : AT 80-120C            FOR 10-30SEC.</p>										
10	RESISTANCE TO SOLDERING HEAT	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	<p>DIP : SOLDER TEMPERATURE OF 270+/-5C            DIP TIME :10+/-1SEC.            EACH TERMINATION SHALL BE FULLY IMMERSSED AND PREHEATED AS FOLLOWING:</p> <table border="1" data-bbox="1005 772 1340 918"> <thead> <tr> <th>STEP</th> <th>TEMP.(C)</th> <th>TIME (SEC.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>80-100</td> <td>60</td> </tr> <tr> <td>2</td> <td>150-180</td> <td>60</td> </tr> </tbody> </table> <p>MEASURE AT ROOM TEMP. AFTER COOLING FOR            CLASS I : 24 +/- 2 HOURS            CLASS II : 48 +/- 4 HOURS</p>	STEP	TEMP.(C)	TIME (SEC.)	1	80-100	60	2	150-180	60
		STEP	TEMP.(C)		TIME (SEC.)								
		1	80-100		60								
		2	150-180		60								
		CAPACITANCE	CHARACTERISTIC		CAP. CHANGE	<p>WITHIN +/-2.5% OR +/-0.25uF WHICHEVER IS LARGER</p>							
			CLASS I		B		WITHIN +/-7.5%						
					F		WITHIN +/-20%						
			CLASS II										
Q	30pF AND OVER : Q>= 1000 LESS THAN 30pF : Q>= 400+20C												
Tan delta	TO SATISFY THE SPECIFIED INITIAL VALUE.												
INSULATION RESISTANCE	TO SATISFY THE SPECIFIED INITIAL VALUE.												
WITHSTANDING VOLTAGE	TO SATISFY THE SPECIFIED INITIAL VALUE.												
11	VIBRATION TEST	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	<p>THE CAPACITOR SHALL BE SUBJECTED TO A HARMONIC MOTION HAVING A TOTAL AMPLITUDE OF 1.5mm.</p> <p>THE ENTIRE FREQUENCY RANGE, FROM 10 TO 55Hz AND RETURN TO 10Hz, SHALL BE TRAVERSED IN 1 MINUTE.</p> <p>THIS CYCLE SHALL BE PERFORMED 2 HOURS IN EACH THERE MUTUALLY PERPENDICULAR DIRECTION, FOR TOTAL PERIOD OF 6 HOURS.</p>									
		CAPACITANCE	CHARACTERISTIC		CAP. CHANGE								
			CLASS I		B	WITHIN +/-5%							
					F	WITHIN +/-20%							
			CLASS II										
		Q	30pF AND OVER: Q>= 1000 LESS THAN 30pF : Q>= 400+20C										
		Tan delta	TO SATISFY THE SPECIFIED INITIAL VALUE.										
		INSULATION RESISTANCE	TO SATISFY THE SPECIFIED INITIAL VALUE.										

\* THE INITIAL VALUE OF CLASS II MLCC SHALL BE MEASURED AFTER THE HEAT TREATMENT OF 150 +/-10C ,1hr AND SITTING OF 48+/-4hr AT ROOM TEMPERATURE & ROOM HUMIDITY.

# Multilayer Chip Capacitors – Array

NO	ITEM	PERFORMANCE	TEST CONDITION		
12	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	TEMPERATURE : 40+/-2 C RELATIVE HUMIDITY:90-95 %RH TEST TIME : 500 +12/-0 Hr.  MEASURE AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24+/-2 Hr. CLASS II : 48+/-4 Hr.		
	CAPACITANCE	CHARACTERISTIC		CAPACITANCE CHANGE	
		CLASS I		WITHIN +/-5% OR +/-0.5uF WHICHEVER IS LARGER	
		CLASS II		B	WITHIN +/-12.5%
		F		WITHIN +/-30%	
	Q CLASS I	30pF AND OVER : Q>= 350 10 ~30pF : Q>= 275 + 2.5C LESS THAN 10pF : Q>= 200 + 10C			
Tan delta CLASS II	CHAR.	25V and over	16V		
	B	0.05 MAX	0.05 MAX		
	F	0.075 MAX	0.1 MAX (C<1.0uF) 0.125 MAX (C>=1.0uF)		
INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 1,000 Mohm OR 50Mohm uF PRODUCT WHICHEVER IS SMALLER.				
13	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	APPLIED VOLTAGE : RATED VOLTAGE TEMPERATURE : 40+/-2 C RELATIVE HUMIDITY:90-95%RH TEST TIME : 500 +12/-0 Hr.CURRENT APPLIED : 50mA MAX.  MEASUREING AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24+/-2 Hr. CLASS II : 48+/-4 Hr.		
	CAPACITANCE	CHARACTERISTIC		CAPACITANCE CHANGE	
		CLASS I		WITHIN +/-7.5% OR +/-0.75uF WHICHEVER IS LARGER	
		CLASS II		B	WITHIN +/-12.5%
		F		WITHIN +/-30%	
	Q CLASS I	30pF AND OVER : Q>= 200 30pF AND BELOW : Q>= 100 + 10/3C			
Tan delta CLASS II	CHAR.	25V and over	16V		
	B	0.05 MAX	0.05 MAX		
	F	0.075 MAX	0.1 MAX (C<1.0uF) 0.125 MAX (C>=1.0uF)		
INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 500 Mohm OR 25Mohm uF PRODUCT, WHICHEVER IS SMALLER.				

# Multilayer Chip Capacitors – Array

NO	ITEM	PERFORMANCE	TEST CONDITION											
14	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	APPLIED VOLTAGE : 200% OF RATED VOLTAGE TEST TIME : 1000 +48/-0 Hr. CURRENT APPLIED : 50mA MAX.  <table border="1"> <thead> <tr> <th>CHAR.</th> <th>TEMP.</th> </tr> </thead> <tbody> <tr> <td>CLASS I</td> <td>125 +/-3 C</td> </tr> <tr> <td rowspan="2">CLASS II</td> <td>B</td> <td>125 +/-3 C</td> </tr> <tr> <td>F</td> <td>85 +/-3 C</td> </tr> </tbody> </table> (INITIAL VALUE MEASUREMENT) FOR CLASS II CAPACITORS, 200 % OF RATED VOLTAGE SHALL BE APPLIED FOR 1 HOUR AT THE MAXIMUM OPERATING TEMPERATURE, THEN KEEP IT AT ROOM TEMPERATURE. FOR 48 +/- 4 Hrs.	CHAR.	TEMP.	CLASS I	125 +/-3 C	CLASS II	B	125 +/-3 C	F	85 +/-3 C		
	CHAR.	TEMP.												
	CLASS I	125 +/-3 C												
	CLASS II	B		125 +/-3 C										
		F		85 +/-3 C										
	CAPACITANCE	CHARACTERISTIC		CAP. CHANGE										
CLASS I		WITHIN +/-3% OR +/-0.3pF,WHICHEVER IS LARGER												
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	B	0.05 MAX	0.05 MAX											
	F	0.075 MAX	0.1 MAX (C<1.0uF) 0.125 MAX (C>=1.0uF)											
INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 1,000 Mohm OR 50 Mohm uF PRODUCT WHICHEVER IS SMALLER.													
15	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.	CAPACITORS SHALL BE SUBJECTED TO FIVE CYCLES OF THE TEMPERATURE CYCLE AS FOLLOWING  <table border="1"> <thead> <tr> <th>STEP</th> <th>TEMP.(C)</th> <th>TIME (MIN)</th> </tr> </thead> <tbody> <tr> <td rowspan="2">1</td> <td>MIN. RATED TEMP. +0/-3</td> <td rowspan="2">30</td> </tr> <tr> <td>25</td> </tr> <tr> <td rowspan="2">3</td> <td>MAX. RATED TEMP. +3/-0</td> <td rowspan="2">30</td> </tr> <tr> <td>25</td> </tr> </tbody> </table> MEASURE AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24+/-2 Hr. CLASS II : 48+/-4 Hr.	STEP	TEMP.(C)	TIME (MIN)	1	MIN. RATED TEMP. +0/-3	30	25	3	MAX. RATED TEMP. +3/-0	30	25
	STEP	TEMP.(C)		TIME (MIN)										
	1	MIN. RATED TEMP. +0/-3		30										
		25												
	3	MAX. RATED TEMP. +3/-0		30										
		25												
CAPACITANCE	CHARACTERISTIC	CAP. CHANGE												
	CLASS I	WITHIN +/-2.5% OR +/-0.25pF WHICHEVER IS LARGER												
	CLASS II	WITHIN +/-20%												
Q CLASS I	30 pF AND OVER : Q >= 1000 LESS THAN 30 pF : Q >= 400 + 20C													
Tan delta CLASS II	TO SATISFY THE SPECIFIED INITIAL VALUE													
INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 1,000 Mohm OR 50Mohm uF PRODUCT WHICHEVER IS SMALLER.													